

P-Channel 40-V (D-S), 175°C MOSFET

PRODUCT SUMMARY

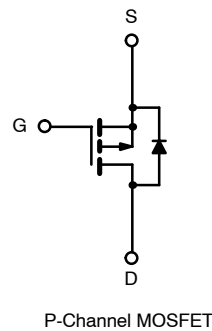
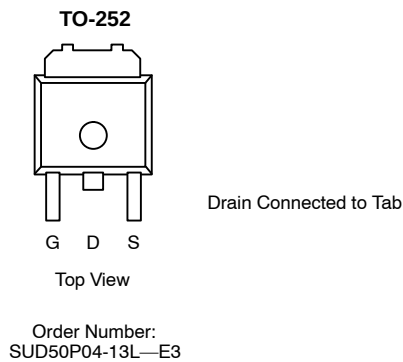
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
-40	0.013 @ $V_{GS} = -10$ V	-60°
	0.022 @ $V_{GS} = -4.5$ V	-48

FEATURES

- TrenchFET® Power MOSFET
- 175°C Maximum Junction Temperature

APPLICATIONS

- Automotive Such As:
 - High-Side Switch
 - Motor Drive
 - 12-V Boardnet



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-40	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ^b	I_D	$T_C = 25^\circ\text{C}$	-60°
		$T_C = 100^\circ\text{C}$	-43
Pulsed Drain Current	I_{DM}	-100	A
Continuous Source Current (Diode Conduction)	I_S	-60°	
Avalanche Current	I_{AS}	-40	
Avalanche Energy	E_{AS}	80	
Maximum Power Dissipation ^b	P_D	$T_C = 25^\circ\text{C}$	93.7 ^b
		$T_A = 25^\circ\text{C}$	3 ^a
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 175	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	R_{thJA}	$t \leq 10$ sec.	15	°C/W
		Steady State	40	
Maximum Junction-to-Case	R_{thJC}	1.3	1.6	

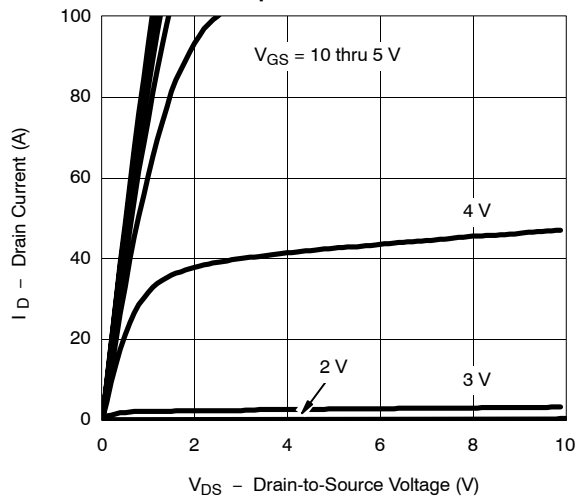
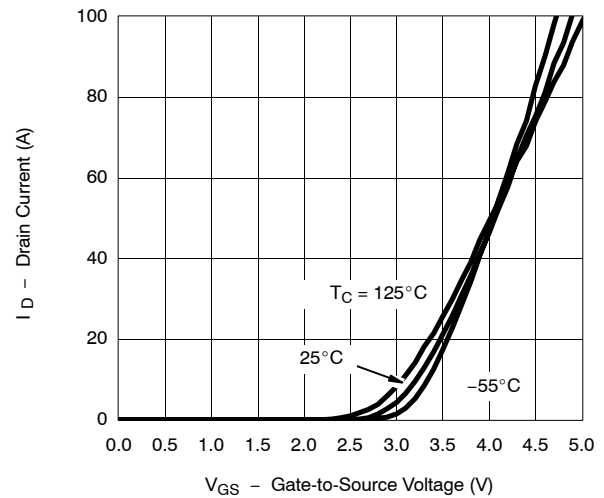
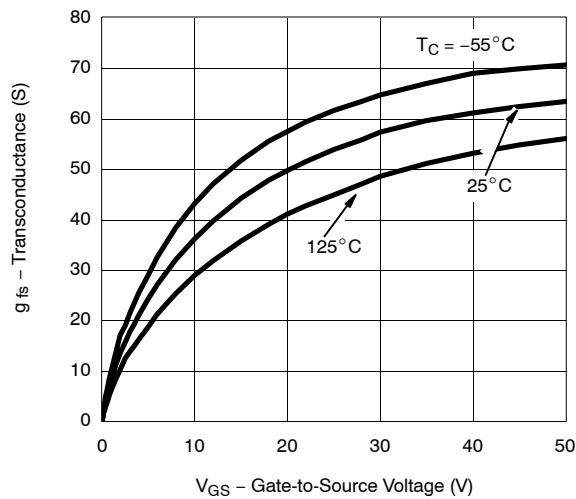
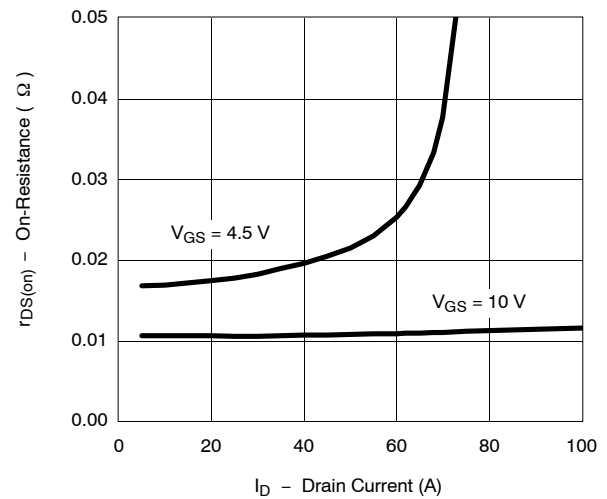
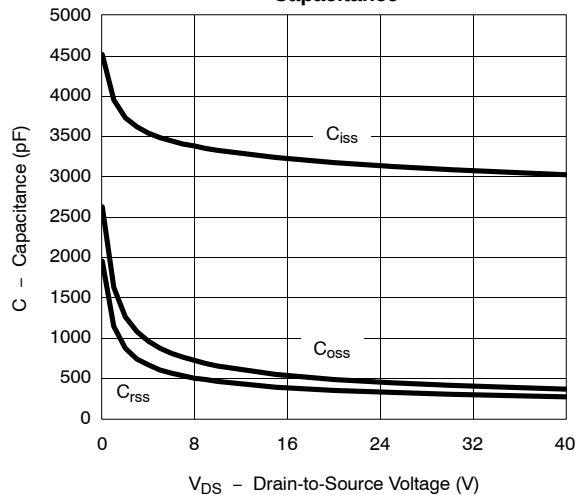
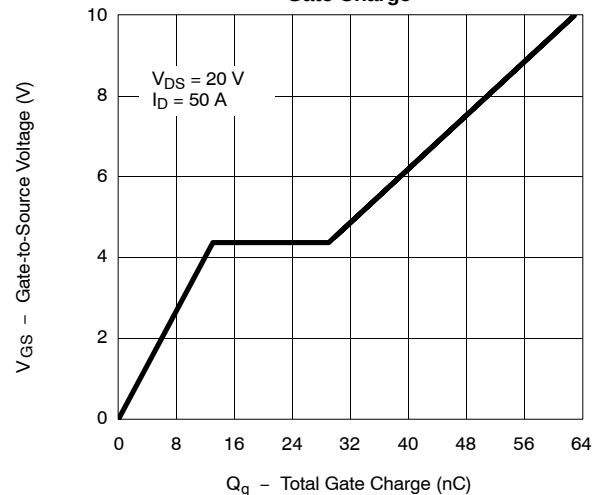
Notes

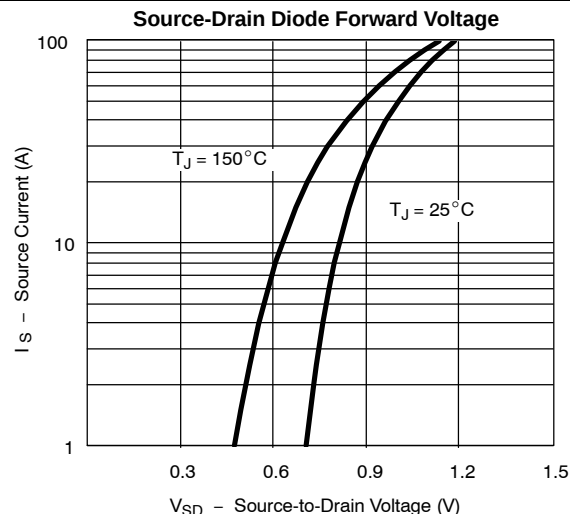
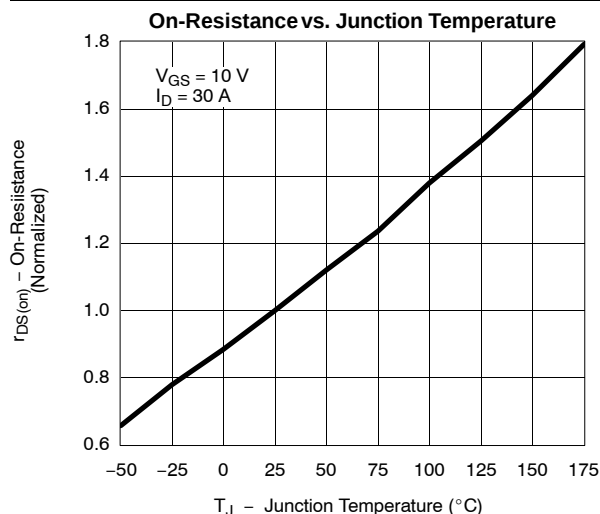
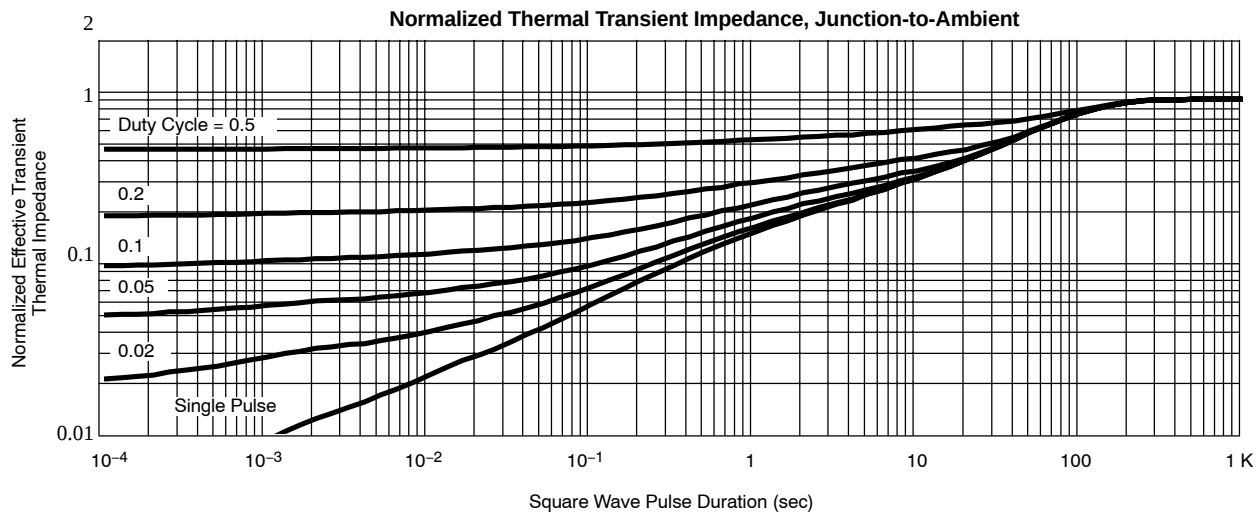
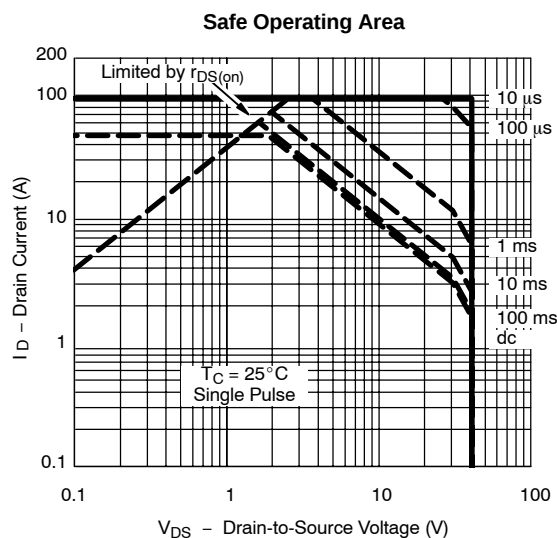
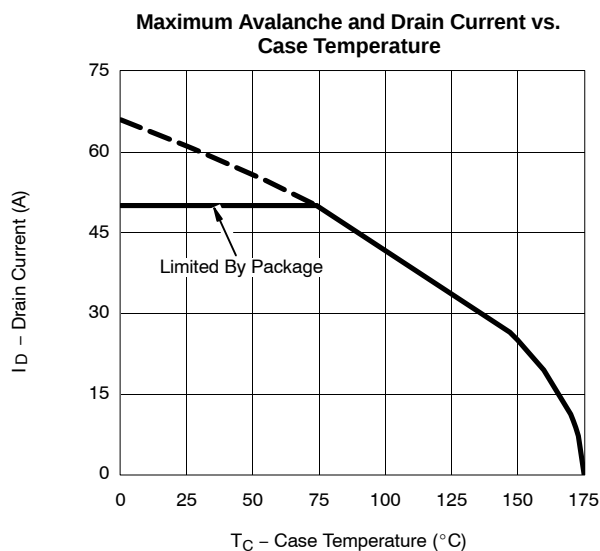
- Surface Mounted on 1" x 1" FR4 Board.
- See SOA curve for voltage derating.
- Calculated based on maximum allowable Junction Temperature. Package limitation current is 50 A.

SPECIFICATIONS (T _J = 25 °C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = -250 μA	-40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA	-1.0		-3.0	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -40 V, V _{GS} = 0 V			-1	μA
		V _{DS} = -40 V, V _{GS} = 0 V, T _J = 125°C			-50	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = -5 V, V _{GS} = -10 V	-50			A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = -10 V, I _D = -30 A		0.0105	0.013	Ω
		V _{GS} = -10 V, I _D = -30 A, T _J = 125°C			0.020	
		V _{GS} = -4.5 V, I _D = -20 A		0.017	0.022	
Forward Transconductance ^a	g _{fs}	V _{DS} = -15 V, I _D = -30 A	15			S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = -25 V, f = 1 MHz		3120		pF
Output Capacitance	C _{oss}			440		
Reverse Transfer Capacitance	C _{rss}			320		
Gate Resistance	R _g	f = 1.0 MHz		4.3		Ω
Total Gate Charge ^c	Q _g	V _{DS} = -20 V, V _{GS} = -10 V, I _D = -50 A		63	95	nC
Gate-Source Charge ^c	Q _{gs}			13		
Gate-Drain Charge ^c	Q _{gd}			16		
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = -20 V, R _L = 0.4 Ω I _D ≅ -50 A, V _{GEN} = -10 V, R _g = 2.5 Ω		15	25	ns
Rise Time ^c	t _r			18	30	
Turn-Off Delay Time ^c	t _{d(off)}			60	90	
Fall Time ^c	t _f			47	70	
Source-Drain Diode Ratings and Characteristic (T _C = 25 °C)						
Pulsed Current	I _{SM}				-100	A
Diode Forward Voltage ^a	V _{SD}	I _F = -50 A, V _{GS} = 0 V		-1.0	-1.5	V
Source-Drain Reverse Recovery Time	t _{rr}	I _F = -50 A, di/dt = 100 A/μs		36	55	ns

Notes

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
b. Guaranteed by design, not subject to production testing.
c. Independent of operating temperature.

**TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)****Output Characteristics****Transfer Characteristics****Transconductance****On-Resistance vs. Drain Current****Capacitance****Gate Charge**

TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)**THERMAL RATINGS**



THERMAL RATINGS

